



Complementary Enhancement Mode MOSFET - ESD Protected

Voltage

50 / -60V

Current

0.4A / -0.25A

Features

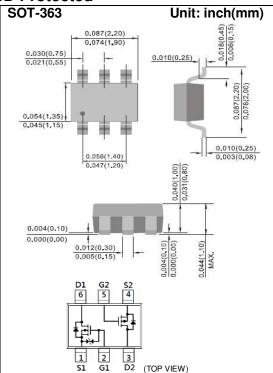
- Advanced Trench Process Technology
- Specially Designed for Switch Load, PWM Application, etc.
- ESD Protected 2KV HBM
- Lead free in compliance with EU RoHS 2011/65/EU directive
- Green molding compound as per IEC61249 Std. (Halogen Free)

Mechanical Data

• Case: SOT-363 Package

• Terminals: Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.0002 ounces, 0.006 grams



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	N-Ch LIMIT	P-Ch LIMIT	UNITS	
Drain-Source Voltage		V _{DS}	50	-60	V
Gate-Source Voltage		V_{GS}	<u>+</u> 20	<u>+</u> 20	V
Continuous Drain Current		I _D	400	-250	mA
Pulsed Drain Current (Note 4)		I _{DM}	1200	-900	mA
Barray Biratiantian	T _a =25°C	D	350		mW
Power Dissipation	Derate above 25°C	P _D	2.8		mW/°C
Operating Junction and Storage Ter	T_{J}, T_{STG}	-55~150		°C	
Typical Thermal resistance - Junction to Ambient (Note 3)		$R_{ heta JA}$	357		°C/W





N-Channel Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						•
Drain-Source Breakdown Voltage	BV _{DSS}	$V_{GS}=0V, I_{D}=250uA$	50	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250uA$	0.5	0.9	1.0	V
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10V, I_{D} = 500mA$	-	1.2	1.5	Ω
		V_{GS} = 4.5V, I_{D} = 200mA	-	1.3	2.5	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 50V, V_{GS} =0V	-	-	1	uA
Gate-Source Leakage Current	I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	<u>+</u> 10	uA
Dynamic (Note 5)						
Total Gate Charge	Q_{g}	V _{DS} =25V, I _D =500mA, V _{GS} =4.5V	-	0.95	-	nC
Gate-Source Charge	Q_gs		-	0.34	-	
Gate-Drain Charge	Q_{gd}		-	0.32	-	
Input Capacitance	Ciss	V _{DS} =25V, V _{GS} =0V, f=1.0MHZ	-	36	-	pF
Output Capacitance	Coss		-	11	-	
Reverse Transfer Capacitance	Crss		-	6.6	-	
Turn-On Delay Time	td _(on)	\/ O5\/ 500~A	-	2.3	-	
Turn-On Rise Time	tr	V_{DD} =25V, I_{D} =500mA, V_{GS} =10V, R_{G} =6 Ω (Note 1,2)	-	20	-	ns
Turn-Off Delay Time	td _(off)		-	7	-	
Turn-Off Fall Time	tf	n _G =012	-	20	-	
Drain-Source Diode						
Maximum Continuous Drain-Source			-	-	400	mA
Diode Forward Current	I _S					
Diode Forward Voltage	V_{SD}	I _S = 500mA, V _{GS} =0V	-	0.9	1.5	V

NOTES:

- 1. Pulse width<a>300us, Duty cycle<a>2%
- 2. Essentially independent of operating temperature typical characteristics.
- 3. ROJA is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper.
- 4. The maximum current rating is package limited.
- 5. Guaranteed by design, not subject to production testing.





P-Channel Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV _{DSS}	V_{GS} =0V, I_D =-250uA	-60	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=-250uA$	-1.0	-1.5	-2.5	V
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =-10V,I _D =-500mA	-	2.4	4	Ω
		V_{GS} =-4.5 V , I_{D} =-200 mA	1	2.7	6	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =-48V, V_{GS} =0V	-	-	-1	uA
Gate-Source Leakage Current	I _{GSS}	$V_{GS}=\underline{+}20V, V_{DS}=0V$	ı	-	<u>+</u> 100	nA
Dynamic (Note 5)						
Total Gate Charge	Q_g	V _{DS} =-25V, I _D =-100mA, V _{GS} =-4.5V	-	1.1	-	nC
Gate-Source Charge	Q_gs		-	0.3	-	
Gate-Drain Charge	Q_gd		-	0.2	-	
Input Capacitance	Ciss	V _{DS} =-25V, V _{GS} =0V,	1	51	-	pF
Output Capacitance	Coss		-	15	-	
Reverse Transfer Capacitance	Crss	f=1.0MHZ	ı	2.2	-	
Turn-On Delay Time	td _(on)	V_{DD} =-25V, I_{D} =-100mA, V_{GS} =-10V, R_{G} =6 Ω (Note 1,2)	ı	4.8	-	ns
Turn-On Rise Time	tr		ı	19	-	
Turn-Off Delay Time	td _(off)		-	52	-	
Turn-Off Fall Time	tf		ı	32	-	
Drain-Source Diode						
Maximum Continuous Drain-Source	,				050	A
Diode Forward Current	I _S		-	-	-250	mA
Diode Forward Voltage	V_{SD}	I _S =-500mA, V _{GS} =0V	-	-0.9	-1.5	V





N-Channel TYPICAL CHARACTERISTIC CURVES

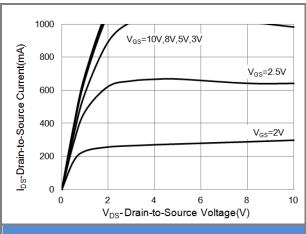


Fig.1 On-Region Characteristics

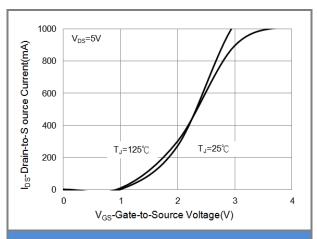


Fig.2 Transfer Characteristics

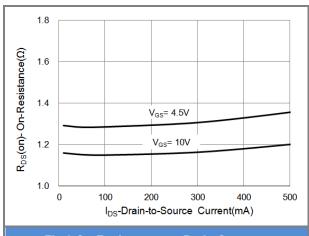


Fig.3 On-Resistance vs. Drain Current

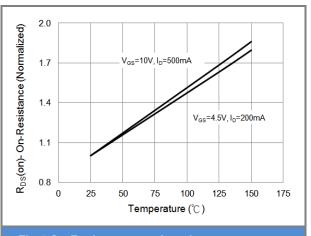
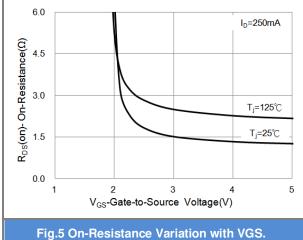
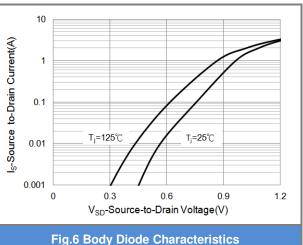


Fig.4 On-Resistance vs. Junction temperature











N-Channel TYPICAL CHARACTERISTIC CURVES

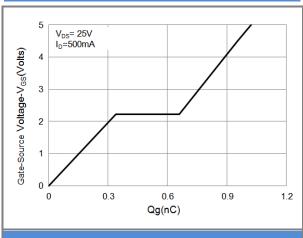


Fig.7 Gate-Charge Characteristics

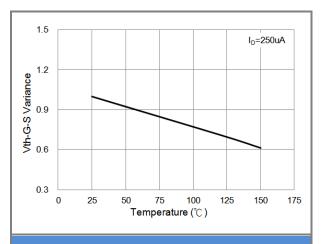


Fig.8 Threshold Voltage Variation with Temperature.

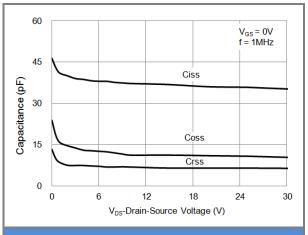


Fig.9 Capacitance vs. Drain-Source Voltage.





P-Channel TYPICAL CHARACTERISTIC CURVES

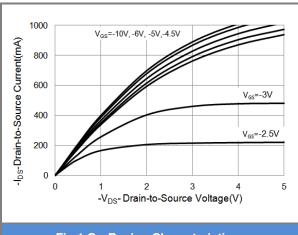


Fig.1 On-Region Characteristics

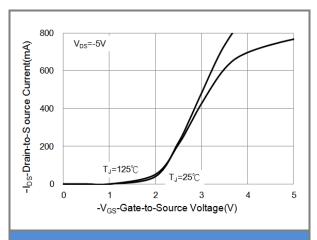


Fig.2 Transfer Characteristics

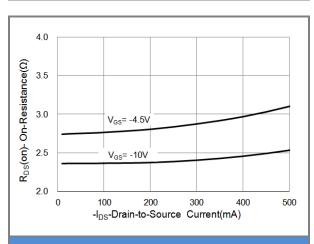


Fig.3 On-Resistance vs. Drain Current

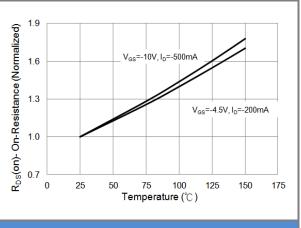


Fig.4 On-Resistance vs. Junction temperature

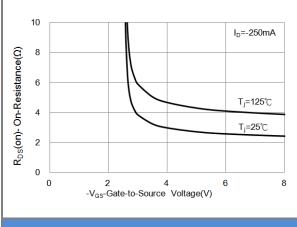
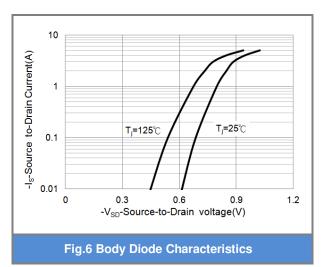


Fig.5 On-Resistance Variation with VGS.







P-Channel TYPICAL CHARACTERISTIC CURVES

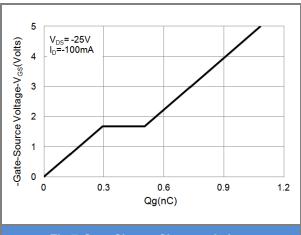


Fig.7 Gate-Charge Characteristics

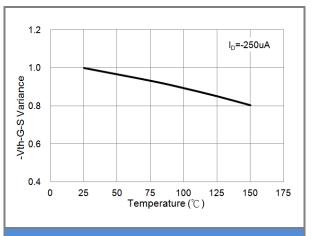


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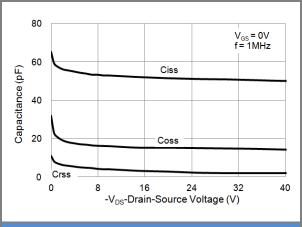


Fig.9 Threshold Voltage Variation with Temperature.

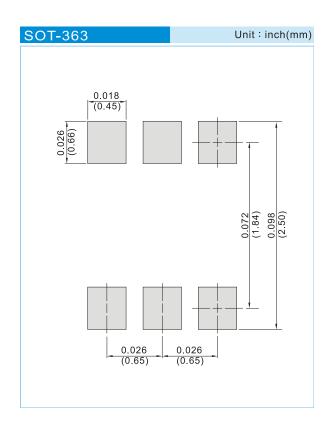




PART NO PACKING CODE VERSION

Part No Packing Code	Package Type	Packing type	Marking	Version
PJT7603_R1_00001	SOT-363	3K pcs / 7" reel	T63	Halogen free
PJT7603_R2_00001	SOT-363	10K pcs / 13" reel	T63	Halogen free

MOUNTING PAD LAYOUT







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